
**SPECIFICATION
FOR
LCM MODULE**

MODULE NO.: LCM1602F-2-Y

REVISION NO.: A

Customer Approval :

--

	SIGNATURE
PREPARED BY	
VERIFIED BY	
APPROVED BY	

RECORDS OF REVISION

Date	Rev.	Description	Page	Design by
2012/9/9	0	New Sample.	-	-
			-	-

Contents

1. SPECIFICATIONS

- 1.1 Features**
- 1.2 Mechanical Specifications**
- 1.3 Absolute Maximum Ratings**
- 1.4 DC Electrical Characteristics**
- 1.5 Backlight & LED Characteristics**

2. MODULE STRUCTURE

- 2.1 Counter Drawing**
- 2.2 Interface Pin Description**
- 2.3 Timing Characteristics**
- 2.4 Instruction Table**
- 2.5 Character Generator ROM**
- 2.6 Inspection Specification**

1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	16characters × 2 lines
LCD Type	STN, POSITIVE (Y-G) ,TRANSMISSIVE
Driver Condition	LCD Module : 1/16Duty , 1/5Bias
Viewing Direction	6 O'clock
Backlight Type	SIDE Y-G
Interface	8-bit MPU interface
Driver IC	SPLC780D1-002-C

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	85(L) * 36(W) * 12.3(T)	mm
Viewing Area	64.3(L) * 16(W)	mm
Dot size	0.56(W) × 0.61(H)	mm
Dot pitch	0.6(W) × 0.65(H)	mm
Character size	2.96(W) × 5.16(H)	mm

1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VDD	-	-0.3	5.5	V
LCD Driver Supply Voltage	VLCD	-	VDD-12	VDD-0.3	V
Input Voltage	V _{IN}	-	-0.3	VDD + 0.3	V
Operating Temperature	T _{OP}	-	-20	70	°C
Storage Temperature	T _{ST}	-	-30	80	°C
Storage Humidity	H _D	Ta < 40 °C	20	90	%RH

1.4 DC Electrical Characteristics

VDD = 5.0V ± 0.2V, GND = 0V, Ta = 25°C

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Logic Supply Voltage	VDD	-	3.0	5.0	5.5	V
Input High Voltage	V _{IH}	-	0.8VDD	-	VDD	V
Input Low Voltage	V _{IL}	-	GND	-	0.3VDD	V
Output High Voltage	V _{OH}	-	0.7VDD	-	VDD	V
Output Low Voltage	V _{OL}	-	GND	-	0.2VDD	V

1.5 Backlight Characteristics

LCD Module without LED Backlight

Electrical / Optical Characteristics

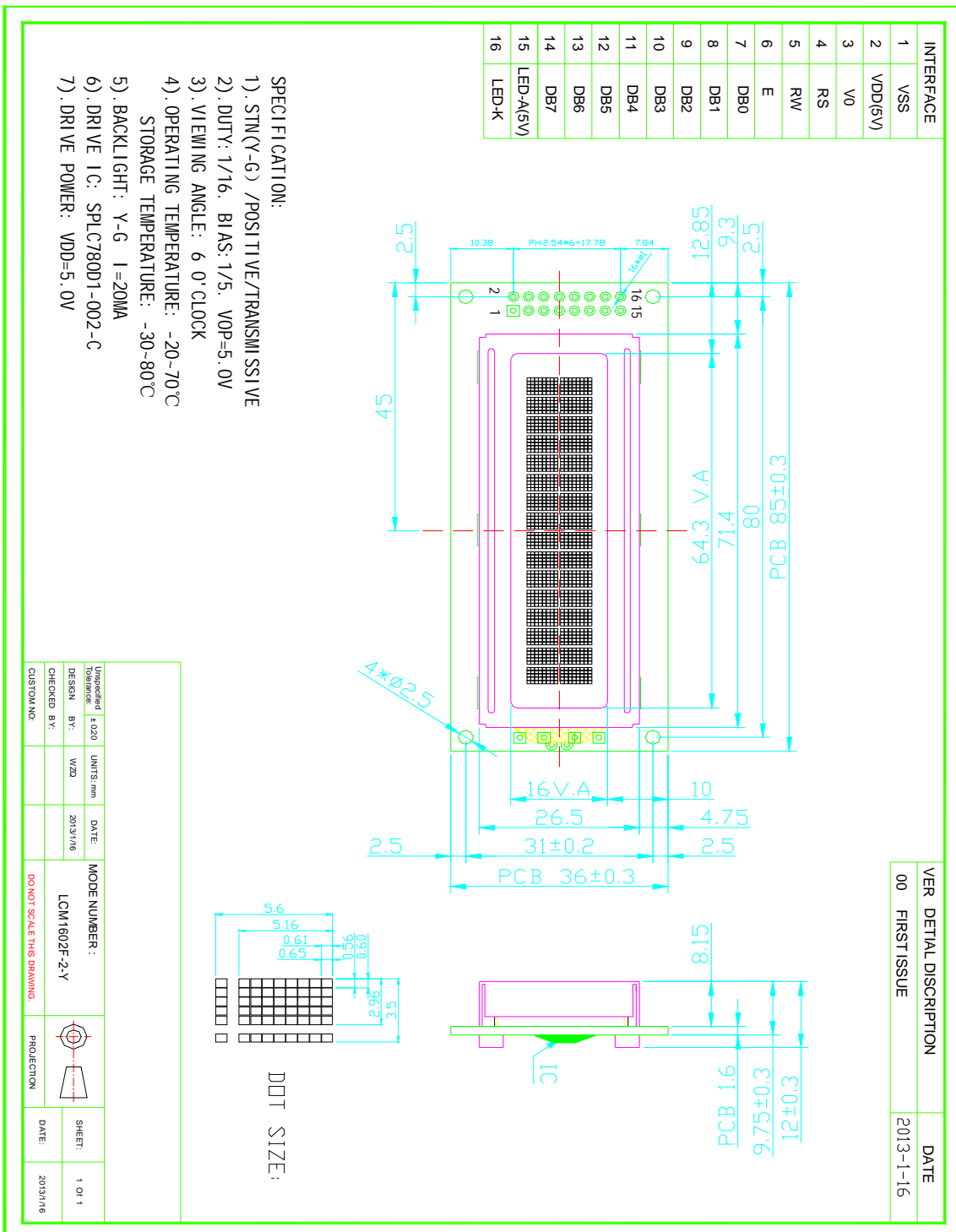
Ta = 25°C

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage	V _f	I _f =20mA	3.1	3.2	3.3	V
Reverse Current	I _r	I _f =5v			--	uA
Average Brightness	I _V	I _f =20mA				cd/m ²
Wavelength (Without LCD)	λ _d	I _f =20mA	--	--	--	nm
Luminous Intensity (without LCD)	L _v Sub	I _f =20mA				cd/m ²
Uniformity	Δ%	I _v Min / I _v Max *100%	--	-	-	%
Color	Y-G					

2. MODULE STRUCTURE

2.1 Counter Drawing

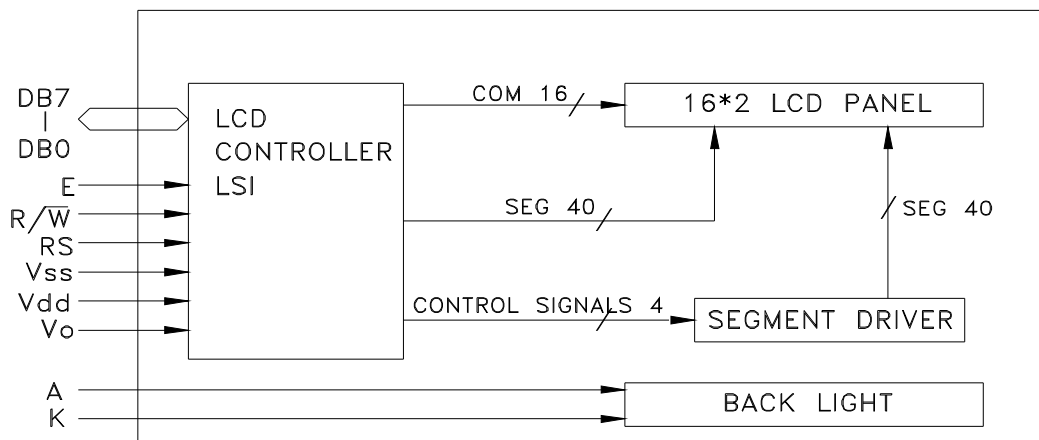
2.1.1 LCM Mechanical Diagram



VER DETAIL DESCRIPTION	DATE
00 FIRST ISSUE	2013-1-16

2.2 Interface Pin Description

No.	Symbol	Function
1	VSS	Ground (0V)
2	VDD	Supply Voltage for Logic (+5.0V)
3	VO	Contrast Adjustment
4	RS	Data/Instruction Select
5	R/W	Read/Write Select
6	E	Enable Signal
7	DB0	Data Bus
8	DB1	Data Bus
9	DB2	Data Bus
10	DB3	Data Bus
11	DB4	Data Bus
12	DB5	Data Bus
13	DB6	Data Bus
14	DB7	Data Bus
15	LED_A	LED Power Supply + (5.0V)
16	LED_K	LED Power Supply - (0V)



2.3 Timing Characteristics

DC Characteristics

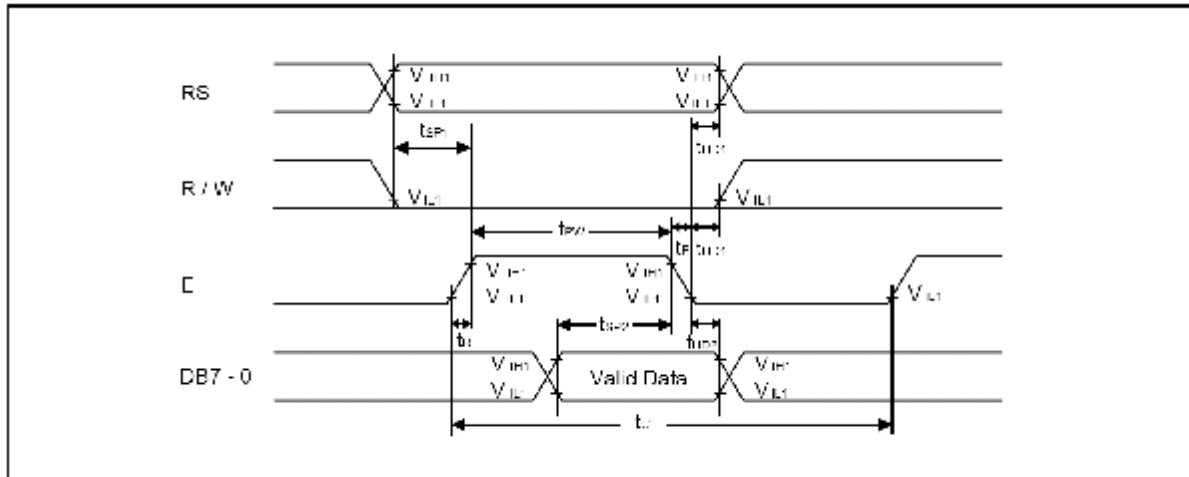
Characteristics	Symbol	Limit			Unit	Test Condition
		Min.	Typ.	Max.		
Operating Current	I_{DD}		0.55	0.8	mA	External clock (Note)
Input High Voltage	V_{IH1}	2.2	-	VDD	V	Pins:(E, RS, RW, DB7 - 0)
Input Low Voltage	V_{IL}	-0.3	-	0.6	V	
Input High Voltage	V_{IH2}	VDD-1	-	VDD	V	Pin OSC1
Input Low Voltage	V_{IL2}	-0.2	-	1.0	V	Pin OSC1
Input High Current	I_{IH}	-2.0	-	2.0	μ A	Pins: (RS, RW, DB7 - 0)
Input Low Current	I_{IL}	-20.0	-50.0	-100.0	μ A	VDD = 5.0V
Output High Voltage (TTL)	V_{OH1}	2.4	-	VDD	V	$I_{OH} = -0.1$ mA Pins: DB7 - 0
Output Low Voltage (TTL)	V_{OL1}	-	-	0.4	V	$I_{OL} = 0.1$ mA Pins: DB7 - 0
Output High Voltage (CMOS)	V_{OH2}	(0.9V _{DD})	-	V _{DD}	V	$I_{IH} = 40.0$ μ A, Pins: CL1, CL2, M, D
Output Low Voltage (CMOS)	V_{OL2}	-	-	0.1VDD	V	$I_{OL} = 40.0$ μ A, Pins: CL1, CL2, M, D
Driver ON Resistance (COM)	R_{COM}	-	-	70.0	K Ω	$I_{DS} = \pm 50.0$ μ A, $V_{DS} = 4.0$ V Pins: COM16 - 1
Driver ON Resistance (SEG)	R_{SEG}			30.0	K Ω	$I_{DS} = \pm 50.0$ μ A, $V_{DS} = 4.0$ V Pins: SEG40 - 1
LCD Voltage	V_{LCD}	3.0	-	11.0	V	VDD - V5, 1/4 bias or 1/5 bias

Note: $f_{OSC} = 250.0$ KHz, VDD = 5.0V, pin E = 'L', RS, RW, DB7 - 0 are open, all outputs are no loads.

AC Characteristics

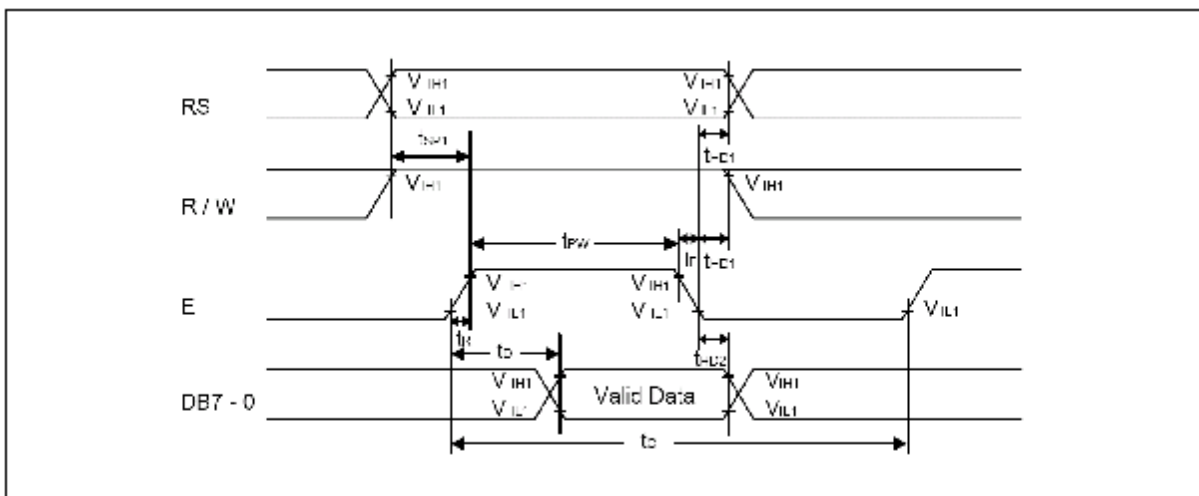
Characteristics	Symbol	Limit			Unit	Test Condition
		Min.	Typ.	Max.		
OSC Frequency	f_{OSC}	190.0	270.0	350.0	KHz	VDD = 5.0V $R_f = 91.0$ K $\Omega \pm 2\%$

Timing Diagram
Writing mode



Characteristics	Symbol	Limit			Unit	Test Condition
		Min.	Typ.	Max.		
E Cycle Time	t_C	400.0	-	-	ns	Pin E
E Pulse Width	t_{PW}	150.0	-	-	ns	Pin E
E Rise/Fall Time	t_{C1}, t_{C2}	-	-	25.0	ns	Pin E
Address Setup Time	t_{SP1}	30.0	-	-	ns	Pins: RS, R/W, E
Address Hold Time	t_{HP1}	10.0	-	-	ns	Pins: RS, R/W, E
Data Setup Time	t_{SD2}	40.0	-	-	ns	Pin: DB7-0
Data Hold Time	t_{HD2}	10.0	-	-	ns	Pin: DB7-0

Read mode



Characteristics	Symbol	Limit			Unit	Test Condition
		Min.	Typ.	Max.		
E Cycle Time	t_{ec}	400.0	-	-	ns	Fin E
E Pulse Width	t_{ep}	150.0	-	-	ns	Fin E
E Rise/Fall Time	t_{er}, t_{ef}	-	-	25.0	ns	Fin E
Address Setup Time	t_{adr}	30.0	-	-	ns	Fin: RS, R/W,E
Address Hold Time	t_{ahd}	10.0	-	-	ns	Fin: RS, R/W,E
Data Output Delay Time	t_{do}	-	-	100.0	ns	Fin: DB7 - 0
Data hold time	t_{dhp}	20.0	-	-	ns	Fin DB7 - 0

2.4 Instruction Table

◆ Display Control Instruction

Instruction	Instruction Code										Description	Execution time ($F_{osc} = 270KHz$)
	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM and set DDRAM address to "00H" from AC	1.52ms
Return Home	0	0	0	0	0	0	0	0	1	-	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.52ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S	Assign cursor moving direction and enable the shift of entire display	38 μ s
Display ON/OFF Control	0	0	0	0	0	0	1	D	C	B	Set display(D) cursor(C), and blinking of cursor(B) on/off control bit	38 μ s
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L			Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data.	38 μ s
Function Set	0	0	0	0	1	DL	N	F	-	-	Set interface data length (DL: 8 bit/4 bit), numbers of display line (N: 2-line/1-line) and display font type (F: 5x10 dots/5x8 dots)	38 μ s
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter	38 μ s
Set DDRAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in counter	38 μ s
Read Busy Flag and Address Counter	0	-	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	38 μ s
Read Data from RAM	1	-	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM).	38 μ s

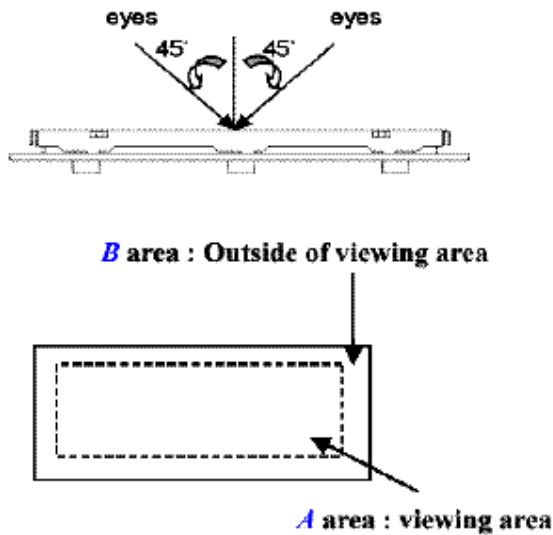
*** don't care

2.5 Character Generator ROM

Upper 4 bit Lower 4 bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	HLLL	HLLH	HLHL	HLLH	HLHL	HLHL	HLHL	HLHL
LLLL				Q	W	P	'	F			日	月	火	.	日	月
LLLH			!	1	A	Q	a	A			口	火	山	.	口	火
LLHL			"	2	B	R	b	r			目	火	山	.	目	火
LLHH			#	3	C	S	c	s			田	火	山	.	田	火
LHLL			\$	4	D	T	d	t			日	火	山	.	日	火
LHLH			%	5	E	U	e	u			日	火	山	.	日	火
LHHL			&	6	F	V	f	v			日	火	山	.	日	火
LHHH			'	7	G	W	g	w			日	火	山	.	日	火
HLLL			0	8	H	X	h	x			日	火	山	.	日	火
HLLH			1	9	I	Y	i	y			日	火	山	.	日	火
HLHL			2	J	Z	j	z				日	火	山	.	日	火
HLHH			3	K	[k	[日	火	山	.	日	火
HHLL			4	>	L	^	l	^			日	火	山	.	日	火
HHLH			5	=	M	_	m	_			日	火	山	.	日	火
HHHL			6	>	N	~	n	~			日	火	山	.	日	火
HHHH			7	?	O		o				日	火	山	.	日	火

2.6 Inspection Specification

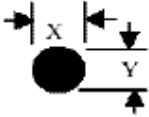
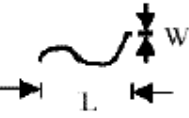
- ◆ Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level II .
- ◆ Equipment : Gauge、 MIL-STD、 Powertip Tester、 Sample
- ◆ Defect Level : Major Defect AQL 0.4; Minor Defect AQL 1.5 .
- ◆ OUT Going Defect Level : Sampling .
- ◆ Manner of appearance test :
 - (1). The test be under 40W×2 fluorescent light ' and distance of view must be at 30 cm.
 - (2). The test direction is base on about around 45° of vertical line. (Fig. 1)
 - (3). Definition of area . (Fig. 2)




◆ Specification:

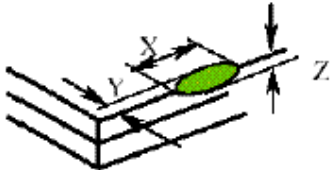

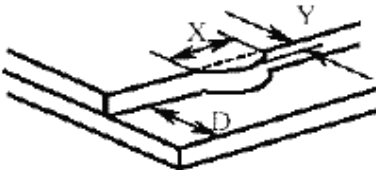
NO	Item	Criterion	level
01	Product condition	1.1 The part number is inconsistent with work order of Production.	Major
		1.2 Mixed production types.	Major
		1.3 Assembled in inverse direction.	Major
02	Quantity	2.1 The quantity is inconsistent with work order of production.	Major
03	Outline dimension	3.1 Product dimension and structure must conform to Structure diagram.	Major
04	Electrical Testing	4.1 Missing line character、 dot and icon.	Major
		4.2 No function or no display.	Major
		4.3 Output data is error.	Major
		4.4 LCD viewing angle defect.	Major
		4.5 Current consumption exceeds product specifications.	Major
05	Black or white dot、 scratch、 contamination Round type	5.1 Round type: 5.1.1 display only : White and black spots on display $\leq 0.25\text{mm}$, no more than Four white or black spots present. Densely spaced : NO more than two spots or lines within 3mm	Minor

◆ Specification :

NO	Item	Criterion	level
05	<p>Black or white dot、scratch、contamination Round type</p>  <p>$\Phi = (x+y)/2$</p> 	<p>5.1.2 Nom-display :</p> <p>Dimension (diameter : Φ) Acceptance(Q'ty)</p> <p>$\Phi \leq 0.10\text{mm}$ Accept no dense</p> <p>$0.10\text{mm} < \Phi \leq 0.20\text{mm}$ 3</p> <p>$0.20\text{mm} < \Phi \leq 0.25\text{mm}$ 2</p> <p>Total 4</p> <p>5.1.3 Line type: Dimension (diameter : Φ) Acceptance (Q'ty)</p> <p>Length width A area B area ---</p> <p>$w \leq 0.03\text{mm}$ Accept no dense Don't count</p> <p>$L \leq 3.0\text{mm}$ $0.03\text{mm} < \Phi \leq 0.05\text{mm}$ 4</p> <p>Don't count</p> <p>$L \leq 2.5\text{mm}$ $0.05\text{mm} < \Phi \leq 0.075\text{mm}$</p> <p>Don't count</p> <p>---</p> <p>$w > 0.075\text{mm}$ As round type</p>	Minor

06	Polarizer Bubble	<p>Dimension (diameter : Φ)</p> <p>A area</p> <p>Acceptance(Q'ty)</p> <p>B area $\Phi \leq 0.20\text{mm}$ Accept no dense Don't count</p> <p>$0.20\text{mm} < \Phi \leq 0.50\text{mm}$ 3 Don't count</p> <p>$0.50\text{mm} < \Phi \leq 1.00\text{mm}$ 2 Don't count</p> <p>$\Phi > 1.00\text{mm}$ 0 Don't count</p> <p>Total quantity 4 Don't count</p>	Minor
07	The crack of glass	<p>● Glass Crack: 7.1 Crack on the circuit of electrode terminal :</p>  <p>X Y Z</p> <p>Front $X \leq 1/5 a$ $Y \leq 1/2 D$ $Z \leq t$</p> <p>Back</p> <p>Neglect</p>	Minor

◆ Specification :

NO	Item	Criterion	Level
07	<p>The crack of glass</p> <p>X: The length of Crack</p> <p>Y: The width of crack</p> <p>Z: The thickness of crack</p> <p>D: terminal length</p> <p>T: The thickness of glass</p> <p>A : The length of glass</p>	<p>● Glass Crack:</p> <p>7.2 General glass crack and corner edge:</p> <p>7.2.1</p>  <p>X Y Z Neglect Out A area Neglect</p> <p>7.2.2</p>  <p>X Y Z Neglect Out A area Neglect</p>	Minor
		<p>7.3 Glass remain:</p>  <p>X Y Neglect $\leq 1/3 d$</p>	Minor

◆Specification :

NO	Item	Criterion	Level
07	<p>The crack of glass</p> <p>X: The length of Crack</p> <p>Y: The width of crack</p> <p>Z: The thickness of crack</p> <p>D: terminal length</p> <p>T: The thickness of glass</p> <p>A : The length of glass</p>	<p>7.4 Corner crack and medial crack:</p> <p>Crack can't enter viewing area</p> <p>Crack can't exceed the half of width of SP width of SP</p> $\frac{1}{2}t < Z \leq 2t$	Minor
08	Backlight elements	<p>8.1 Backlight can't work normally.</p> <p>8.2 Backlight doesn't light or color is wrong.</p> <p>8.3 Illumination source flickers when lit.</p>	Major
09	General appearance	<p>9.1 pin type must match type in specification sheet</p> <p>9.2 No short circuits in components on PCB or FPC</p> <p>9.3 Product packaging must the same as specified on packaging specification sheet.</p> <p>9.4 The folding and peeled off in polarizer are not acceptable</p> <p>9.5 The PCB or FPC between B/L assembled distance (PCB or FPC) is $\leq 1.5\text{mm}$</p>	Major